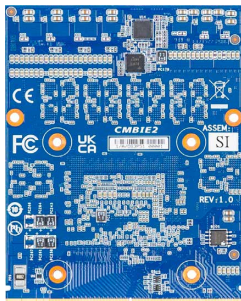
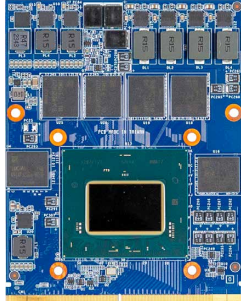


MXM-B-A730M (CMBIE2)

MXM module type B with Intel® Arc™ A730M Graphics



Features

- Intel® Arc™ A730M Graphics
- GDDR6 12GB 192 bit Memory
- Support Xe HPG Architecture
- Support for XMX AI acceleration
- Support 4 x DP2.0 (8K) resolution

Application Scenarios

- AI acceleration
- Digital Signage

Specifications

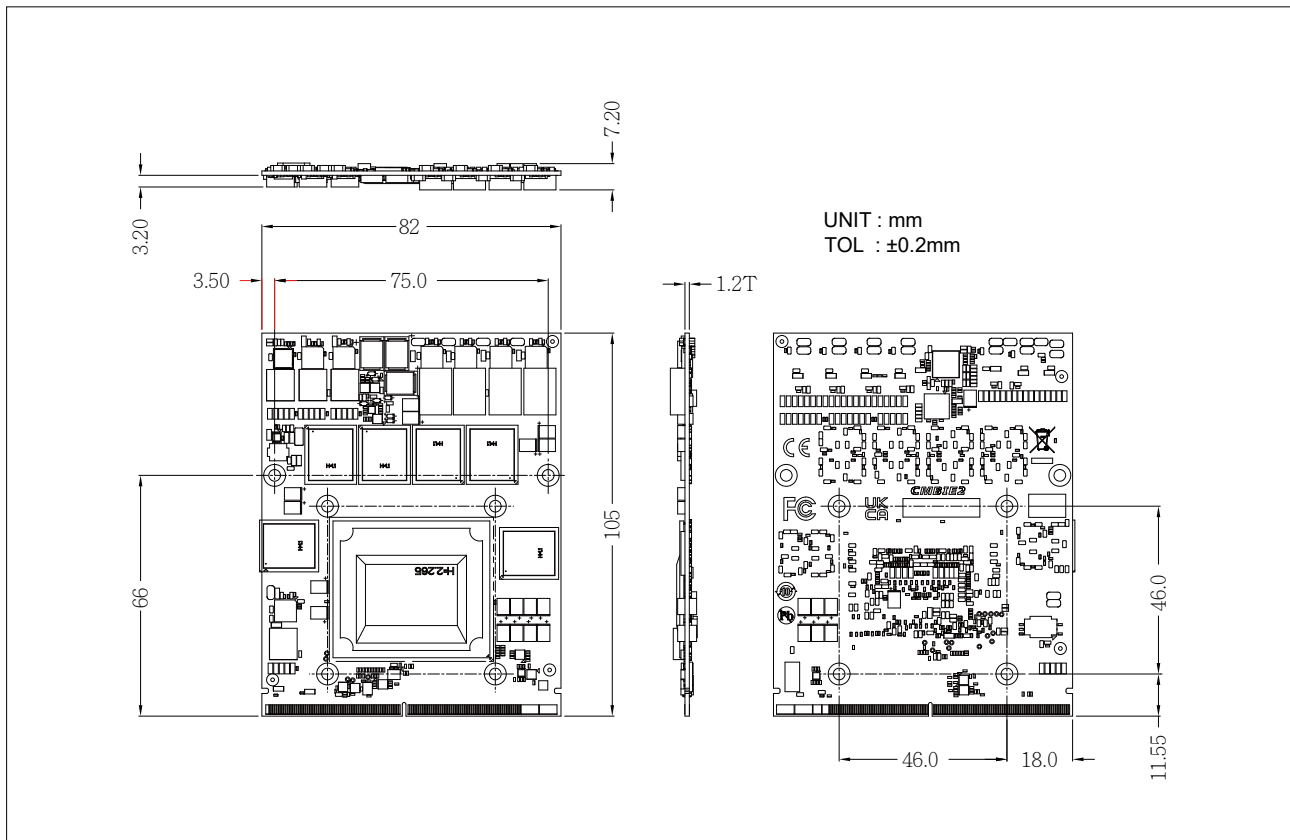
Dimension	MXM module type B 82W x 105D (mm)
GPU	Intel® Arc™ A730M Graphics Microarchitecture: Xe HPG Xe-cores: 24 Intel® XMX Engines: 384 Graphics clock: 1100 MHz TGP: 80-120W
PCI Express configurations	PCI Express 4.0x16
Memory	GDDR6 12GB, 192bit memory bus Memory speed: 14 Gbps Bandwidth: 336 GB/s
Graphics	Reserved 4 x DP 2.0 supporting a maximum resolution of 7680x4320 @60Hz (4 independent display outputs)
OS Compatibility	Windows 10/11 (x64)
Operating Properties	Operating temperature: 0°C to 60°C Operating humidity: 0-90% (non-condensing) Non-operating temperature: -40°C to 85°C Non-operating humidity: 0%-95% (non-condensing)
Packing Content	Carton size: 384 x 251 x 211 (mm) Packing Capacity: 20pcs Single Box size : 168 x 112 x 34 (mm)
Order Information	9CMBIE2MR-SI (Box packing)

GIGAIPC reserves the right to modify or change technical data without prior notice.

Dimension

2024/05/10

Unit: mm



Optional Kit

Part No.	Description	Quantity
25ST4-113106-Y0R	Fansink (Used with P/N: 9CIEPIMR-SI)	1
9CIEPIMR-SI	PCIe-to-MXM adapter	1

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